

## NCE N-Channel Enhancement Mode Power MOSFET

### Description

The NCE40H14 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

### General Features

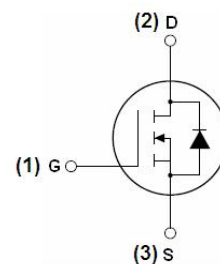
- $V_{DS} = 40V, I_D = 140A$   
 $R_{DS(ON)} < 2.9m\Omega @ V_{GS} = 10V$   
 $R_{DS(ON)} < 5.0 m\Omega @ V_{GS} = 4.5V$
- High density cell design for ultra low  $R_{DS(ON)}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high  $E_{AS}$
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

### Application

- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

**100% UIS TESTED!**

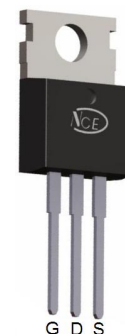
**100%  $\Delta V_{DS}$  TESTED!**



Schematic diagram



Marking and pin assignment



TO-220-3L top view

### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE40H14	NCE40H14	TO-220-3L	-	-	-

### Absolute Maximum Ratings ( $T_C = 25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	40	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D$	140	A
Drain Current-Continuous( $T_C = 100^\circ C$ )	$I_D(100^\circ C)$	99	A
Pulsed Drain Current	$I_{DM}$	560	A
Maximum Power Dissipation	$P_D$	135	W
Derating factor		0.87	W/ $^\circ C$
Single pulse avalanche energy (Note 5)	$E_{AS}$	1180	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 175	$^\circ C$

## Thermal Characteristic

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	$R_{\theta JC}$	1.11	$^{\circ}\text{C/W}$
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## Electrical Characteristics ( $T_c=25^{\circ}\text{C}$ unless otherwise noted)

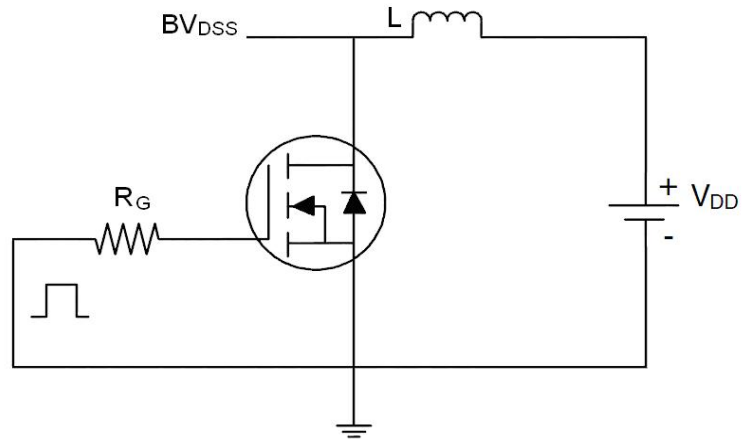
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	40	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics <sup>(Note 3)</sup>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.2	1.9	2.5	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	2.4	2.9	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A	-	3.65	5.0	
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =10V, I <sub>D</sub> =20A	-	30	-	S
Dynamic Characteristics <sup>(Note4)</sup>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V, F=1.0MHz	-	4308	-	pF
Output Capacitance	C <sub>oss</sub>		-	562	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	450	-	pF
Switching Characteristics <sup>(Note 4)</sup>						
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =20V, I <sub>D</sub> =2A, R <sub>L</sub> =1Ω V <sub>GS</sub> =10V, R <sub>G</sub> =3Ω	-	14	-	nS
Turn-on Rise Time	t <sub>r</sub>		-	16	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>		-	48	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	20	-	nS
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =20V, I <sub>D</sub> =20A, V <sub>GS</sub> =10V	-	93.2	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	15.6	-	nC
Gate-Drain Charge	Q <sub>gd</sub>		-	20.6	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage <sup>(Note 3)</sup>	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =20A	-	-	1.2	V
Diode Forward Current <sup>(Note 2)</sup>	I <sub>S</sub>		-	-	140	A
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> = 20A di/dt = 100A/μs <sup>(Note3)</sup>	-	42	-	nS
Reverse Recovery Charge	Q <sub>rr</sub>		-	45	-	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

## Notes:

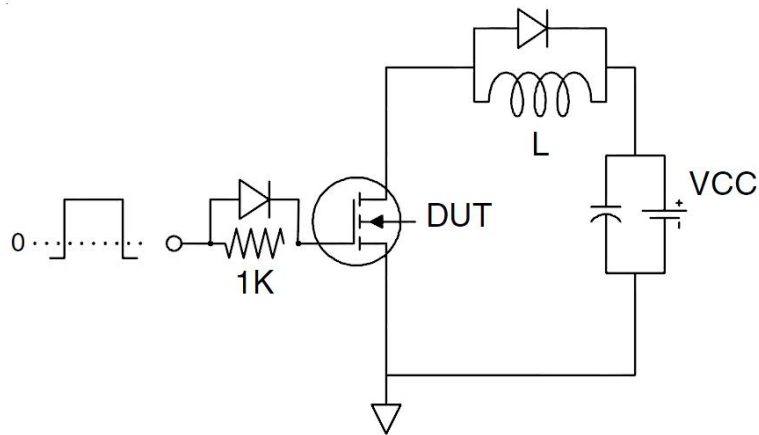
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production
5.  $E_{AS}$  condition :  $T_J=25^{\circ}\text{C}, V_{DD}=20V, V_G=10V, L=0.5mH, R_g=25\Omega$

## Test circuit

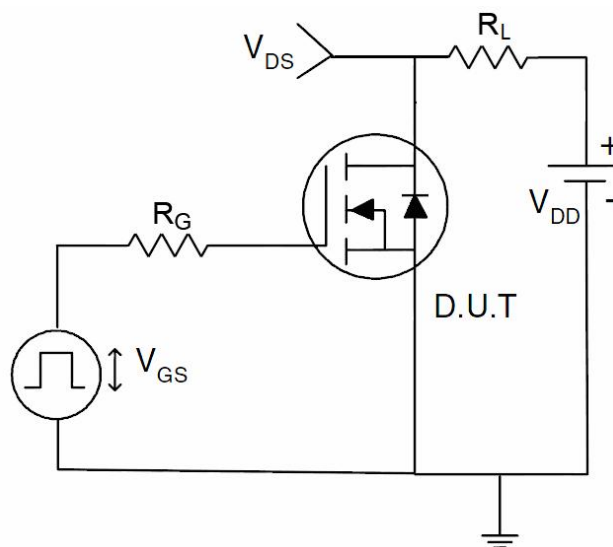
### 1) $E_{AS}$ Test Circuit



### 2) Gate Charge Test Circuit



### 3) Switch Time Test Circuit



## Typical Electrical and Thermal Characteristics (Curves)

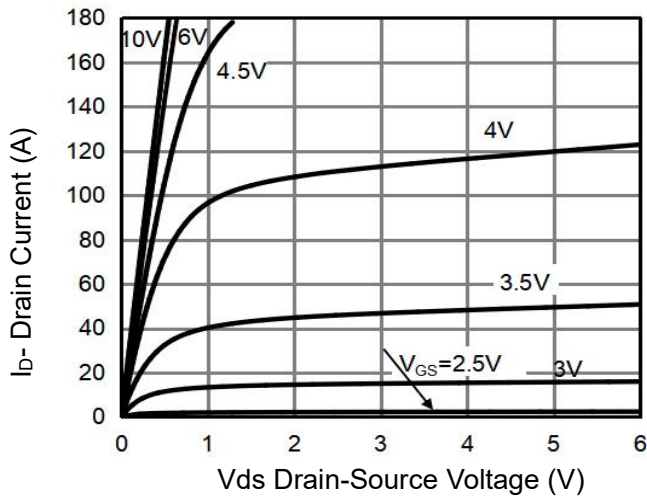


Figure 1 Output Characteristics

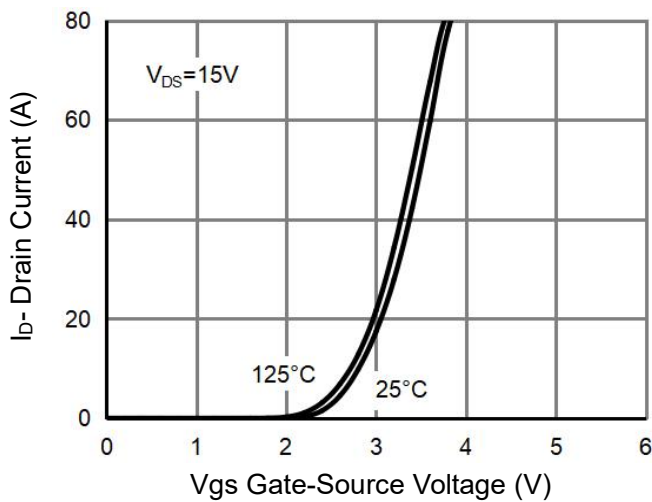


Figure 2 Transfer Characteristics

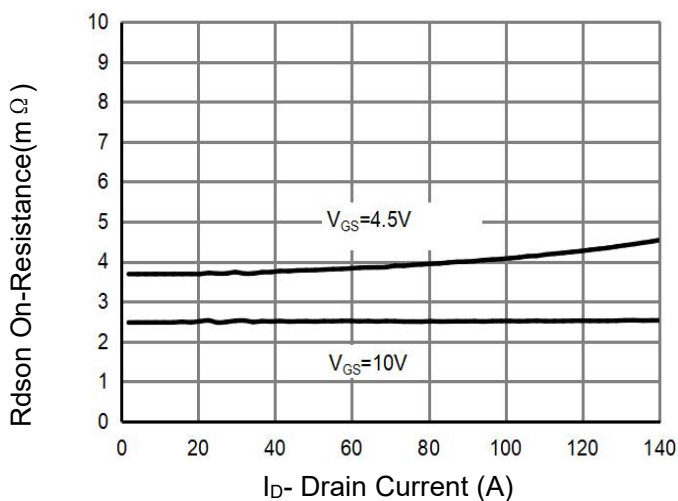


Figure 3  $R_{DS(on)}$ - Drain Current

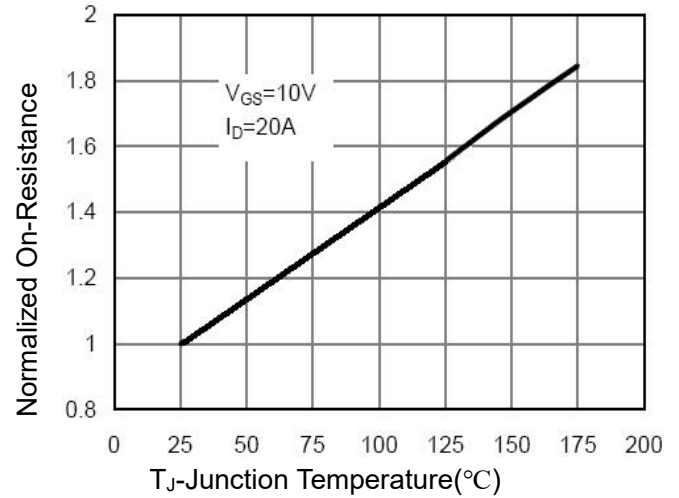


Figure 4  $R_{DS(on)}$ -Junction Temperature

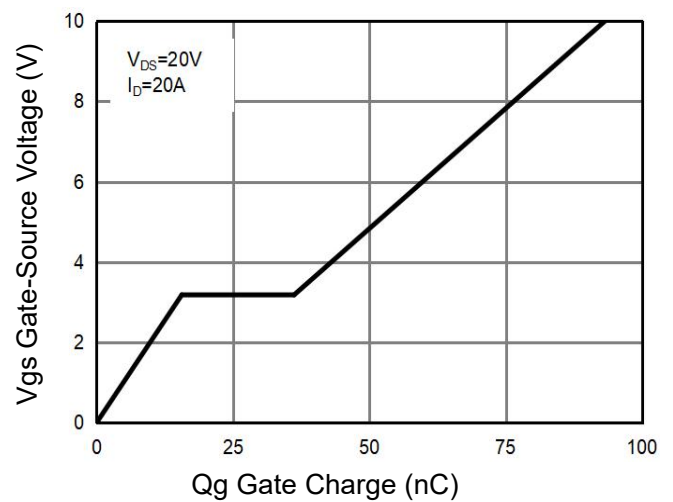


Figure 5 Gate Charge

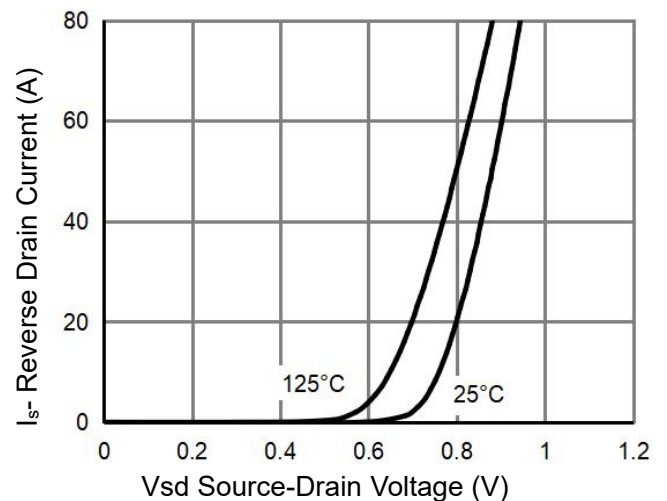
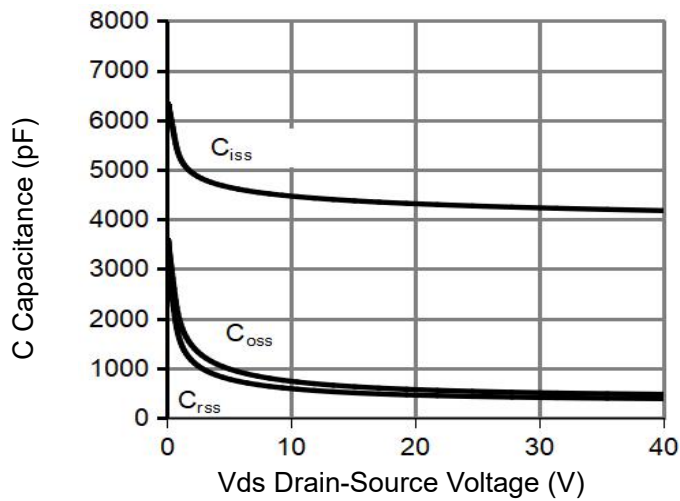
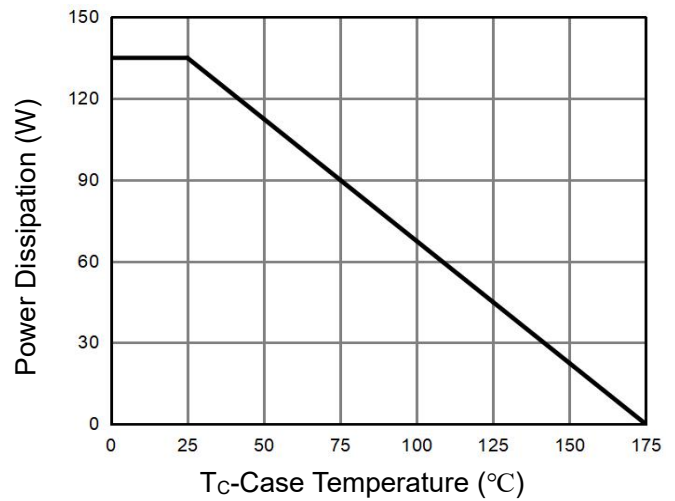


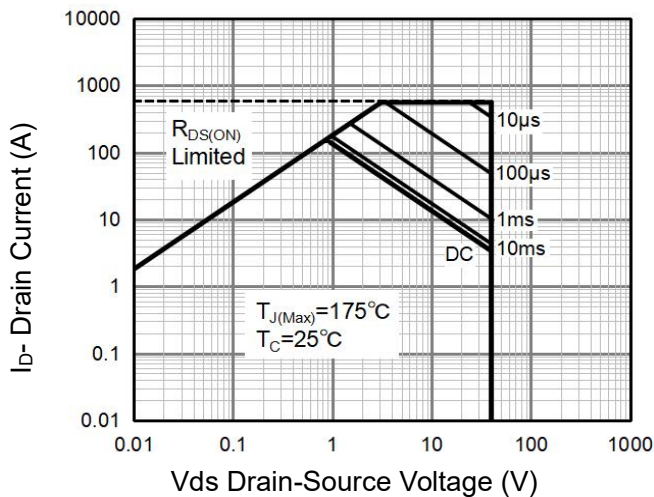
Figure 6 Source- Drain Diode Forward



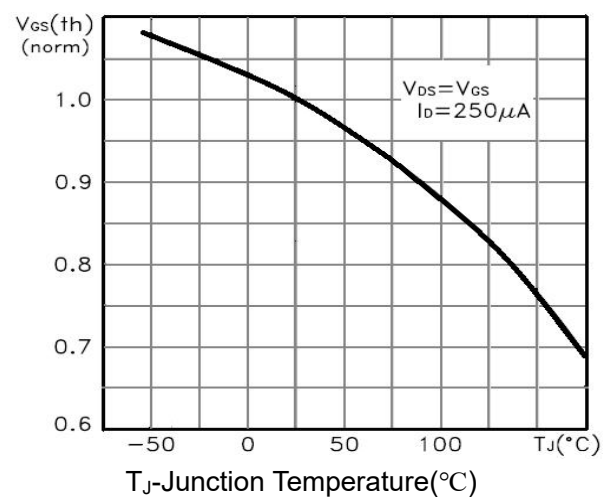
**Figure 7 Capacitance vs  $V_{DS}$**



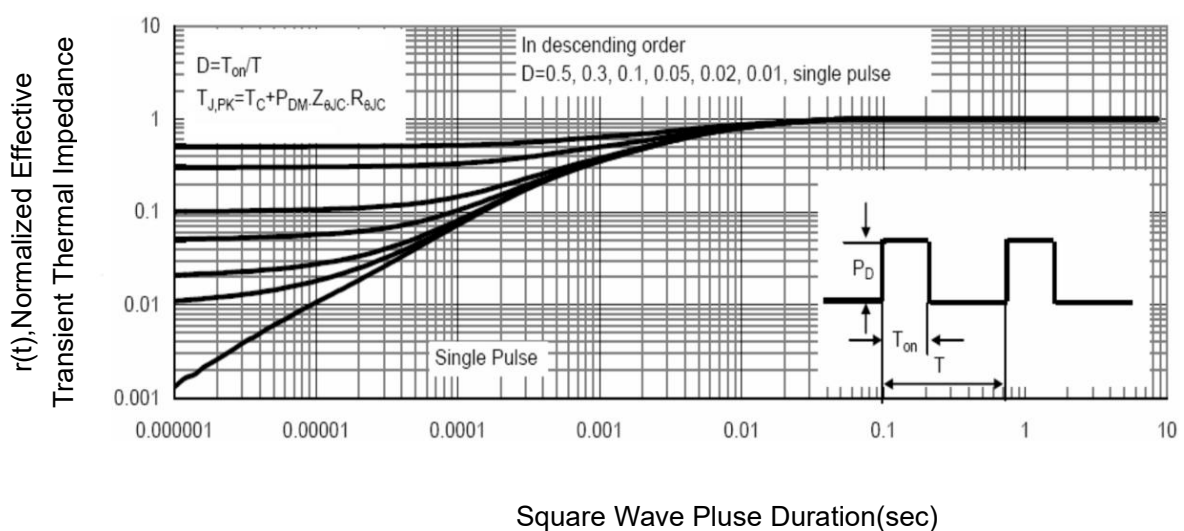
**Figure 9 Power De-rating**



**Figure 8 Safe Operation Area**

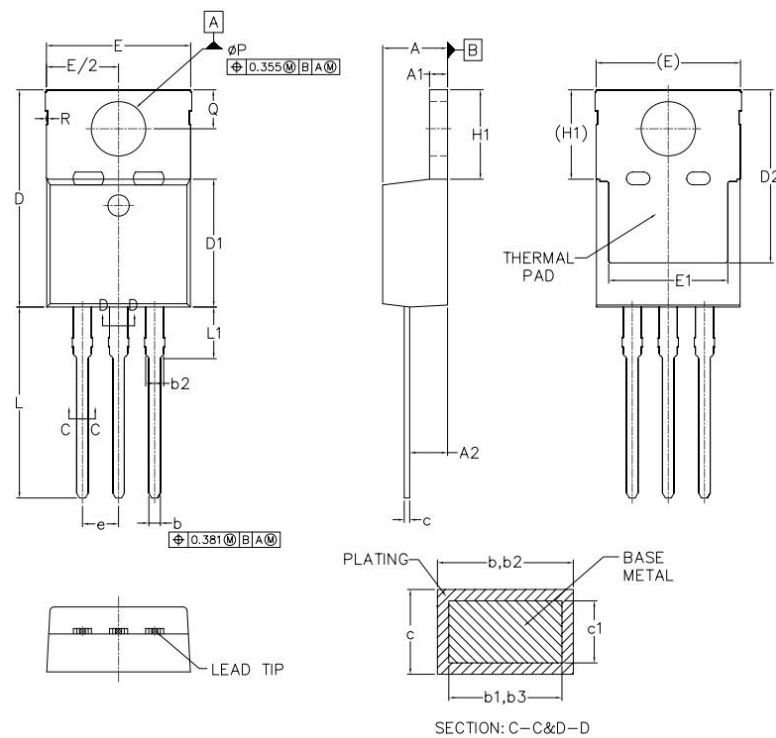


**Figure 10  $V_{GS(th)}$  vs Junction Temperature**



**Figure 11 Normalized Maximum Transient Thermal Impedance**

## TO-220-3L Package Information



SYMBOLS	COMMON	
	MM	
	MIN.	MAX.
A	3.556	4.826
A1	0.508	1.397
A2	2.032	2.921
b	0.381	1.016
b1	0.381	0.965
b2	1.143	1.778
b3	1.143	1.727
c	0.356	0.610
c1	0.356	0.559
D	14.224	16.510
D1	8.382	9.017
D2	12.042	12.878
E	9.652	10.668
E1	6.858	8.890
e	2.540 BSC.	
H1	5.842	6.858
L	12.700	14.732
L1	3.560	4.060
øP	3.810	3.860
Q	2.540	3.048
R	0.127 BSC	

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